MA21D382G

Silicon epitaxial planar type

For high frequency rectification

■ Features

- $I_{F(AV)} = 1.5$ A rectification is possible
- ullet Low forward voltage V_F
- Large non-repetitive peak forward surge current I_{FSM}

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Reverse voltage	V _R	30	V	
Maximum peak reverse voltage	V _{RM}	30	V	
Forward current (Average)	I _{F(AV)}	1.5	A	
Non-repetitive peak forward surge current *	I _{FSM}	30	A	
Junction temperature	Tj	150	°C	
Storage time	T _{stg}	-55 to +150	°C	

Note) *: The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)

■ Package

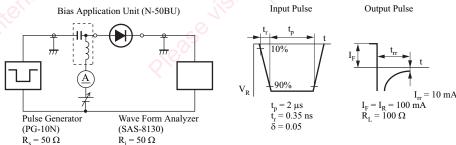
- Code
- SMini2-F2
- Pin Name
 - 1: Anode
 - 2: Cathode
- Marking Symbol: 4U

■ Electrical Characteristics $T_a = 25$ °C±3°C

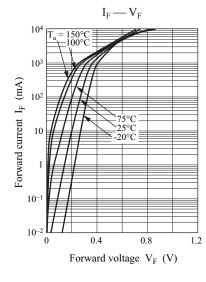
Parameter	Symbol	Conditions Min	Тур	Max	Unit
Forward voltage	V_{F1}	$I_F = 0.5 A$	0.34	0.38	V
	V _{F2}	$I_F = 1.0 \text{ A}$	0.38	0.42	
	V_{F3}	I _F = 1.5 A	0.42	0.46	
Reverse current	I _R	$V_R = 30 \text{ V}$	6,	100	μА
Terminal capacitance	C_{t}	$V_R = 10 \text{ V}, f = 1 \text{ MHz}$	40		pF
Reverse recovery time *	t _{rr}	$I_F = I_R = 100 \text{ mA}, I_{rr} = 10 \text{ mA},$ $R_L = 100 \Omega$	13		ns

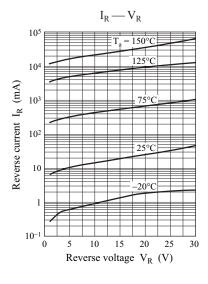
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

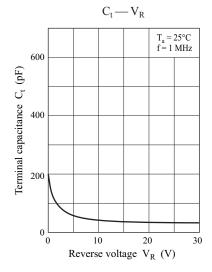
- 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
- 3. *: t_{rr} measurement circuit

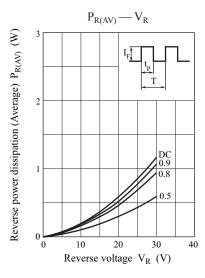


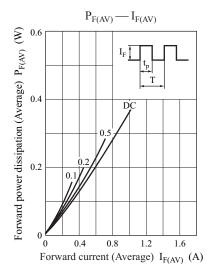
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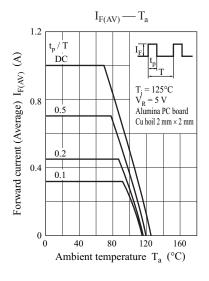


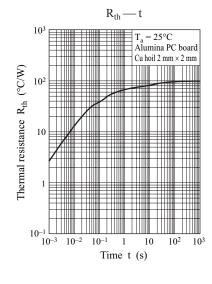


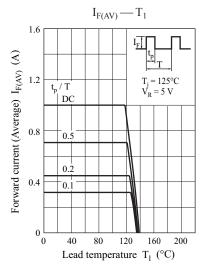








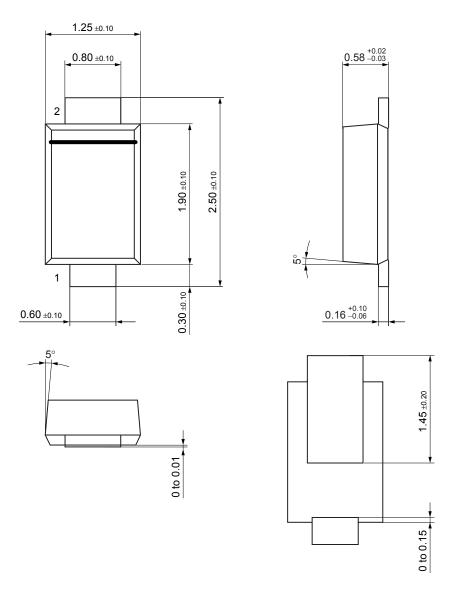




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Panasonic MA21D382G

SMini2-F2 Unit: mm



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